

International Rectifier

POWER MOSFET

THRU-HOLE (TO-257AA)

IRFY440C,IRFY440CM
500V, N-CHANNEL
HEXFET® MOSFET TECHNOLOGY

Product Summary

Part Number	R _{D(on)}	I _D	Eyelets
IRFY440C	0.85 Ω	7.0A	Glass
IRFY440CM	0.85 Ω	7.0A	Glass

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.



Absolute Maximum Ratings

	Parameter	Units
I _D @ V _{GS} = 10V, T _C = 25°C	Continuous Drain Current	7.0
I _D @ V _{GS} = 10V, T _C = 100°C	Continuous Drain Current	4.4
I _{DM}	Pulsed Drain Current ①	28
P _D @ T _C = 25°C	Max. Power Dissipation	100
	Linear Derating Factor	0.8
V _{GS}	Gate-to-Source Voltage	±20
E _A S	Single Pulse Avalanche Energy ②	510
I _{AR}	Avalanche Current ①	7.0
E _{AR}	Repetitive Avalanche Energy ①	10
dV/dt	Peak Diode Recovery dV/dt ③	3.5
T _J	Operating Junction	-55 to 150
T _{STG}	Storage Temperature Range	°C
	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)
	Weight	4.3 (Typical)
		g

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (Unless Otherwise Specified)

	Parameter	Min	Typ	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	500	—	—	V	$V_{GS} = 0\text{V}, I_D = 1.0\text{mA}$
$\Delta BVDSS/\Delta T_J$	Temperature Coefficient of Breakdown Voltage	—	0.78	—	V/ $^\circ\text{C}$	Reference to 25°C , $I_D = 1.0\text{mA}$
RDS(on)	Static Drain-to-Source On-State Resistance	—	—	0.85	Ω	$V_{GS} = 10\text{V}, I_D = 4.4\text{A}$ ④
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
gfs	Forward Transconductance	4.7	—	—	S (m^-1)	$V_{DS} > 15\text{V}, I_{DS} = 4.4\text{A}$ ④
IDSS	Zero Gate Voltage Drain Current	—	—	25	μA	$V_{DS} = 400\text{V}, V_{GS} = 0\text{V}$
		—	—	250		$V_{DS} = 400\text{V}, V_{GS} = 0\text{V}, T_J = 125^\circ\text{C}$
IGSS	Gate-to-Source Leakage Forward	—	—	100	nA	$V_{GS} = 20\text{V}$
IGSS	Gate-to-Source Leakage Reverse	—	—	-100		$V_{GS} = -20\text{V}$
Qg	Total Gate Charge	—	—	68.5	nC	$V_{GS} = 10\text{V}, I_D = 7.0\text{A}$
Qgs	Gate-to-Source Charge	—	—	12.5		$V_{DS} = 250\text{V}$
Qgd	Gate-to-Drain ('Miller') Charge	—	—	42.4		see figures 6 and 13
td(on)	Turn-On Delay Time	—	—	21	ns	$V_{DD} = 250\text{V}, I_D = 7.0\text{A}, R_G = 9.1\Omega$
tr	Rise Time	—	—	73		
td(off)	Turn-Off Delay Time	—	—	72		
tf	Fall Time	—	—	51		see figure 10
LS + LD	Total Inductance	—	6.8	—	nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
Ciss	Input Capacitance	—	1300	—	pF	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}$
Coss	Output Capacitance	—	310	—		$f = 1.0\text{MHz}$
Crss	Reverse Transfer Capacitance	—	120	—		see figure 5

Source-Drain Diode Ratings and Characteristics

	Parameter	Min	Typ	Max	Units	Test Conditions
IS	Continuous Source Current (Body Diode)	—	—	7.0	A	
ISM	Pulse Source Current (Body Diode) ①	—	—	28		
VSD	Diode Forward Voltage	—	—	1.5	V	$T_J = 25^\circ\text{C}, I_S = 7.0\text{A}, V_{GS} = 0\text{V}$ ④
trr	Reverse Recovery Time	—	—	700	nS	$T_J = 25^\circ\text{C}, I_F = 7.0\text{A}, dI/dt \leq 100\text{A}/\mu\text{s}$ $V_{DD} \leq 50\text{V}$ ④
QRR	Reverse Recovery Charge	—	—	8.9		
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.				

Thermal Resistance

	Parameter	Min	Typ	Max	Units	Test Conditions
RthJC	Junction-to-Case	—	—	1.25	°C/W	Typical socket mount
RthCS	Case-to-sink	—	0.21	—		
RthJA	Junction-to-Ambient	—	—	80		

Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page.

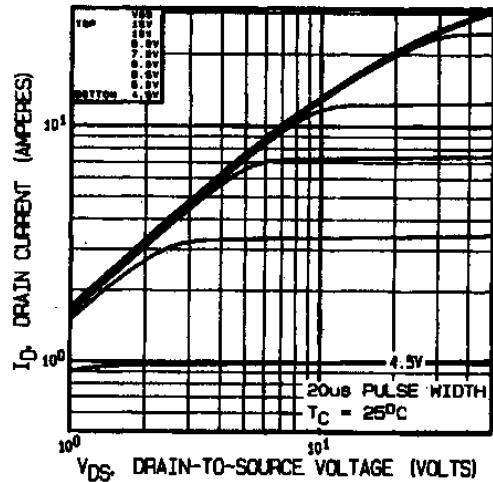


Fig 1. Typical Output Characteristics

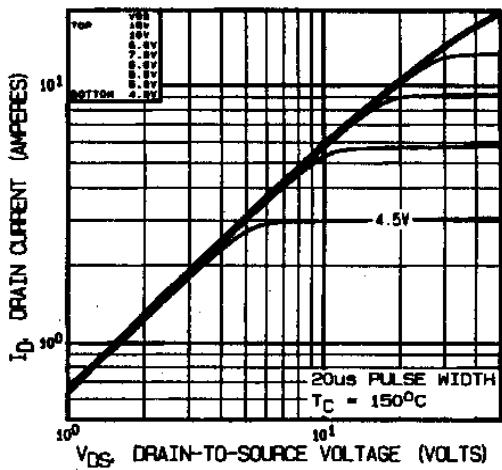


Fig 2. Typical Output Characteristics

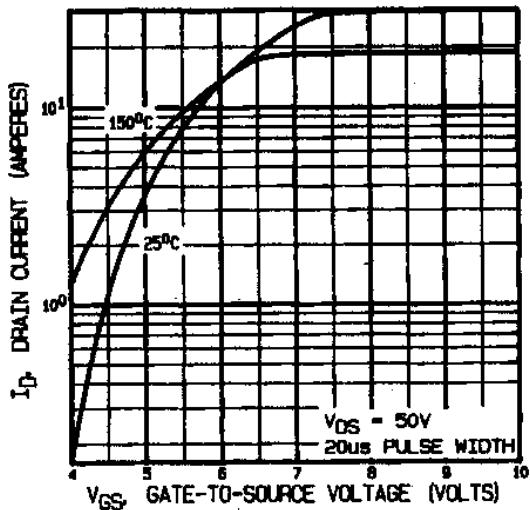


Fig 3. Typical Transfer Characteristics

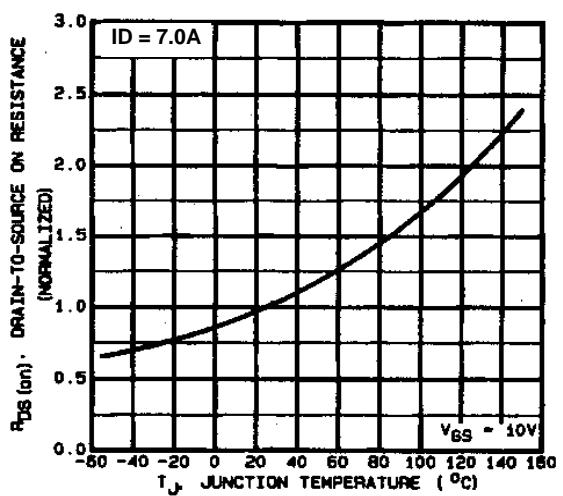


Fig 4. Normalized On-Resistance
Vs. Temperature

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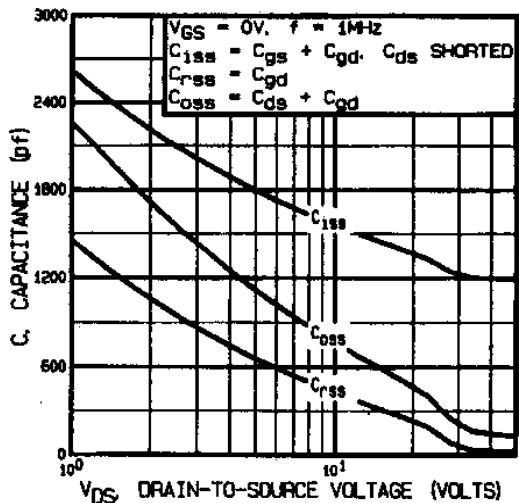


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

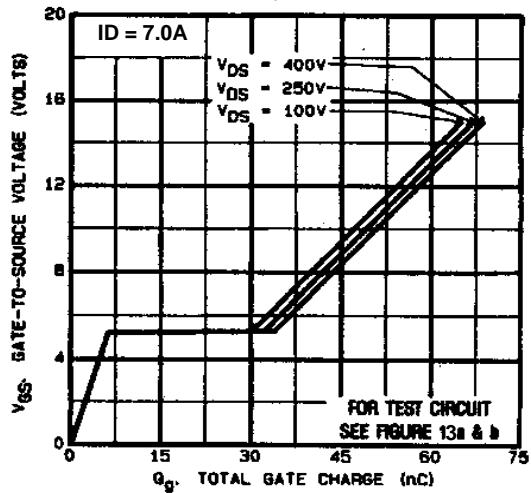


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

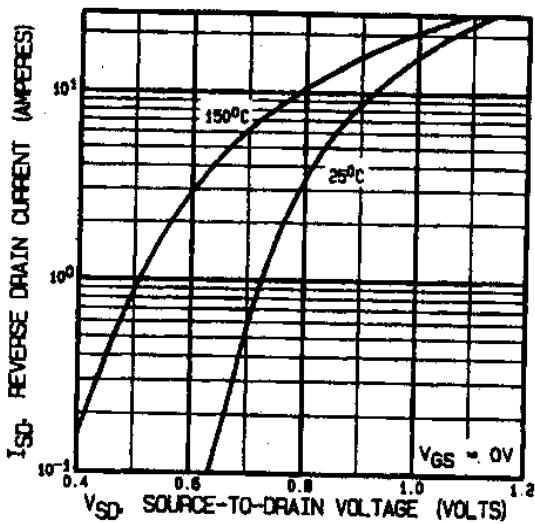


Fig 7. Typical Source-Drain Diode
Forward Voltage

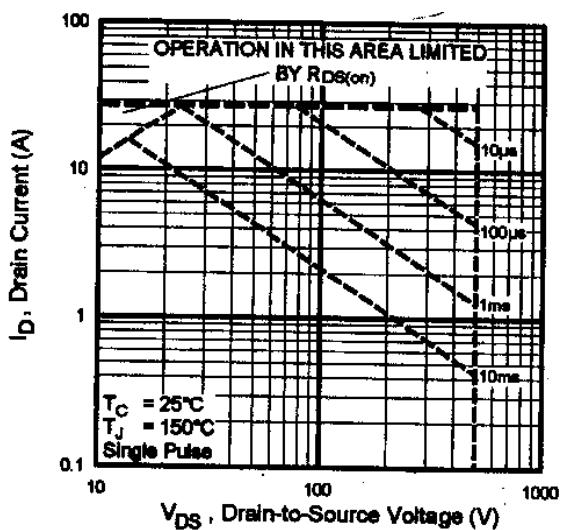


Fig 8. Maximum Safe Operating Area

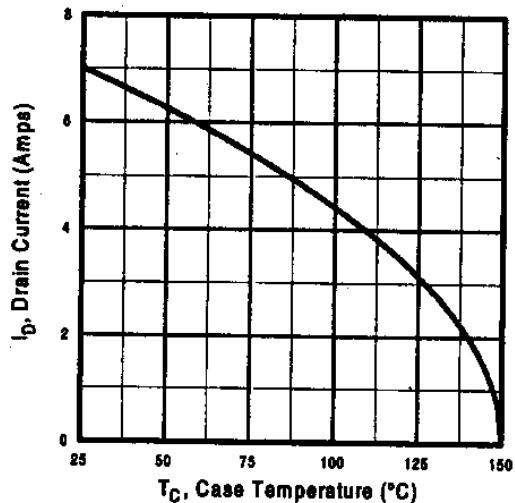


Fig 9. Maximum Drain Current Vs.
Case Temperature

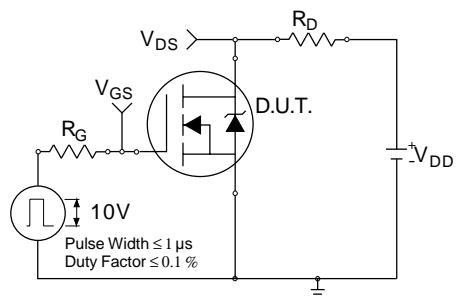


Fig 10a. Switching Time Test Circuit

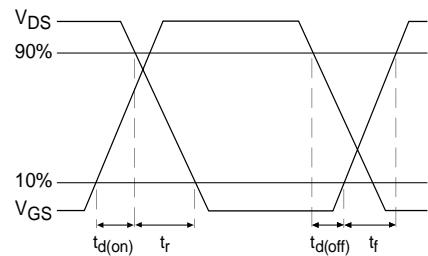


Fig 10b. Switching Time Waveforms

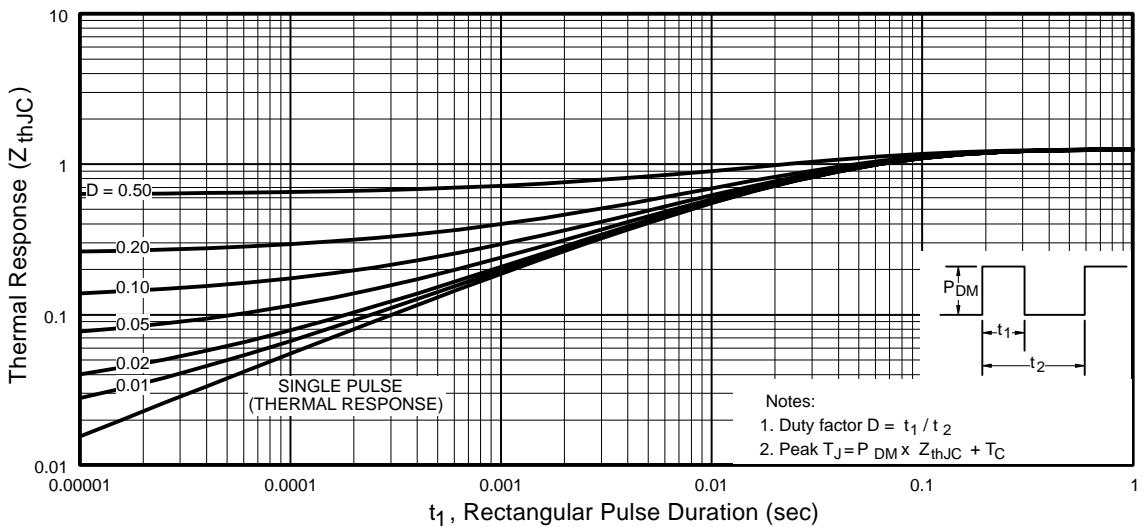


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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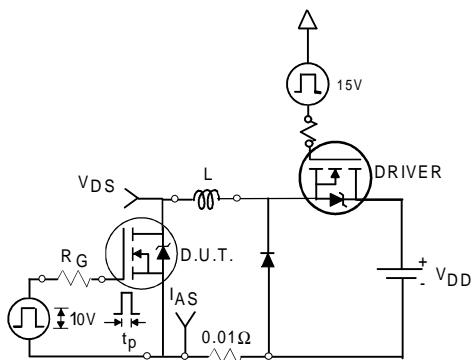


Fig 12a. Unclamped Inductive Test Circuit

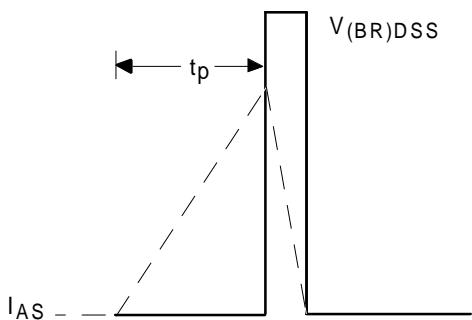


Fig 12b. Unclamped Inductive Waveforms

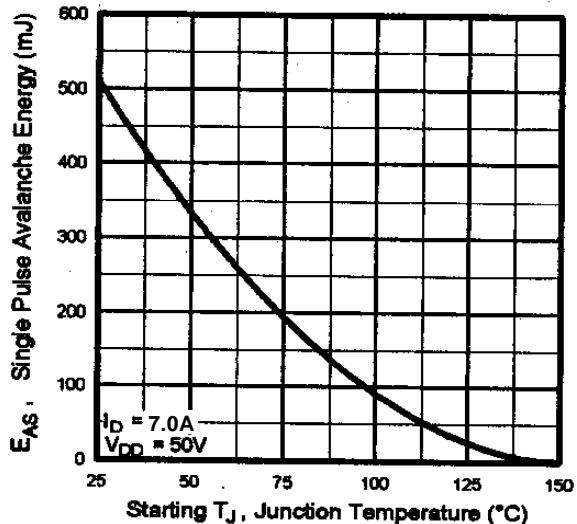


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

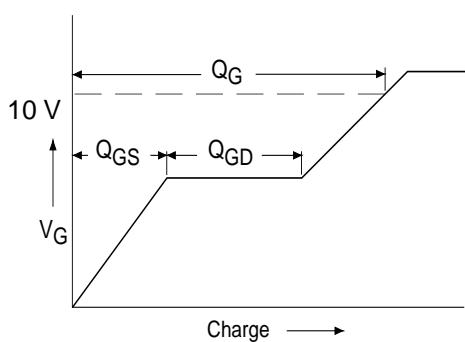


Fig 13a. Basic Gate Charge Waveform

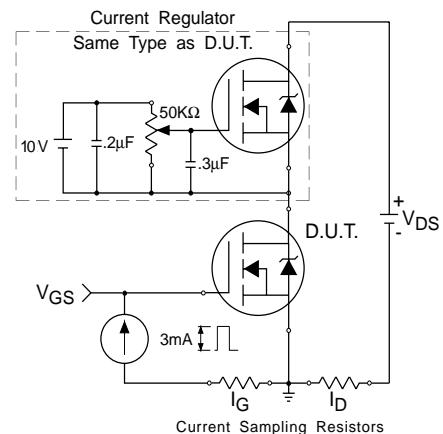


Fig 13b. Gate Charge Test Circuit

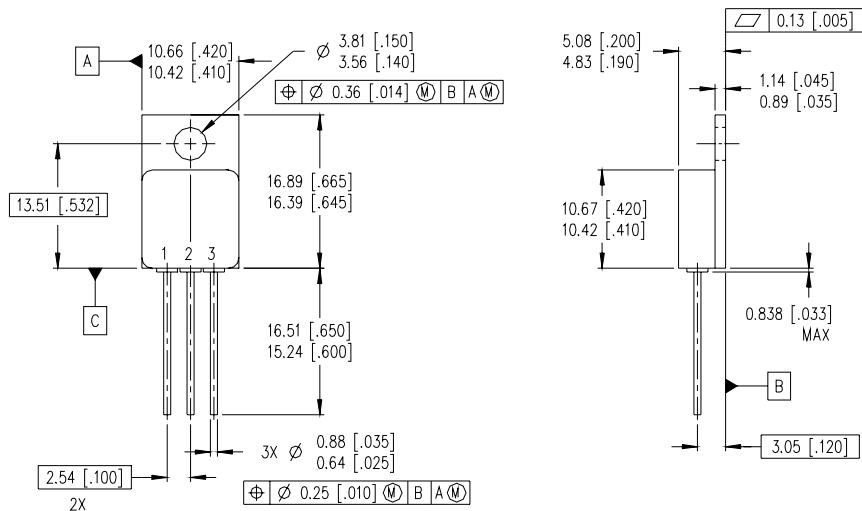
Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② V_{DD} = 50V, starting T_J = 25°C, L = 20mH
Peak I_L = 7.0A, V_{GS} = 10V

③ I_{SD} ≤ 7.0A, di/dt ≤ 100A/μs,
V_{DD} ≤ 500V, T_J ≤ 150°C

④ Pulse width ≤ 300 μs; Duty Cycle ≤ 2%

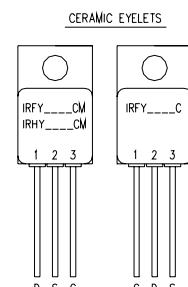
Case Outline and Dimensions — TO-257AA



NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

LEGEND
D – DRAIN
S – SOURCE
G – GATE



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Data and specifications subject to change without notice. 04/01